

1.6X0.8mm INFRARED EMITTING DIODE

Part Number: KP-1608SF4C

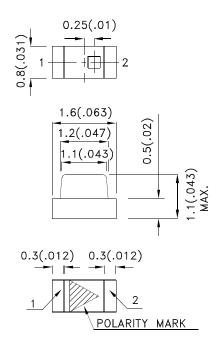
Features

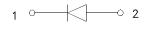
- 1.6mmX0.8mm SMT LED, 1.1mm thickness.
- Mechanically and spectrally matched to the phototransistor.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

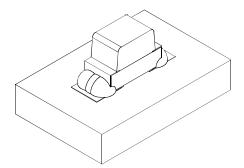
Description

SF4 Made with Gallium Aluminum Arsenide Infrared Emitting diodes.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 4.The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAD0325 APPROVED: WYNEC

REV NO: V.10B CHECKED: Allen Liu

DATE: OCT/24/2012 DRAWN: F.Cui

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Selection Guide

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KP-1608SF4C	SF4 (GaAlAs)	Water Clear	8.0	1.5	120°

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Radiant Intensity/ luminous flux: +/-15%.
- 3. Radiant Intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions	
Forward Voltage [1]	SF4	VF	1.3	1.6	V	IF=20mA	
Reverse Current	SF4	lR		10	uA	VR = 5V	
Capacitance	SF4	С	90		pF	VF=0V;f=1MHz	
Peak Spectral Wavelength	SF4	λP	880		nm	IF=20mA	
Spectral Bandwidth	SF4	Δλ1/2	50		nm	IF=20mA	

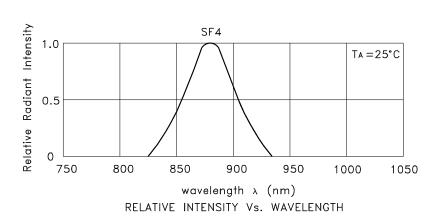
- 1. Forward Voltage: +/-0.1V.
- 2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

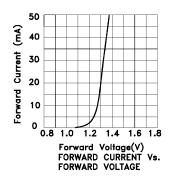
Parameter	Symbol	SF4	Units
Power dissipation	Po	80	mW
DC Forward Current	lF	50	mA
Peak Forward Current [1]	iFS	1.2	Α
Reverse Voltage	VR	5	V
Operating Temperature	TA	-40 To +85	°C
Storage Temperature	Тѕтс	-40 To +85	°C

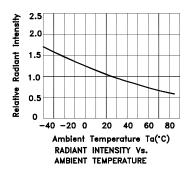
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

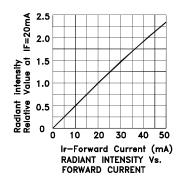
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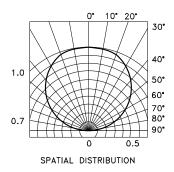


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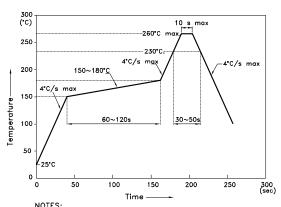
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

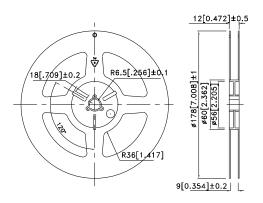
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

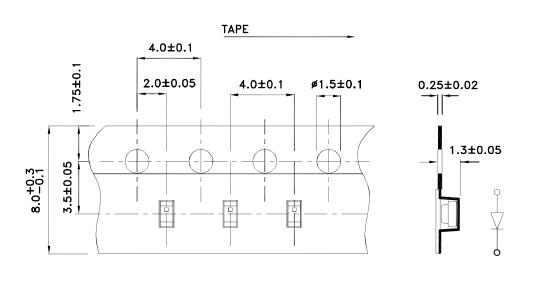
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

δ. 0.8 0.85 0.8

Reel Dimension



Tape Specifications (Units: mm)



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KP-1608SF4C **PACKING & LABEL SPECIFICATIONS** USER DIRECTION OF FEED LABEL-**LABEL** 2,000pcs / Reel 1Reel / Bag OUTSIDE LABEL OUTSIDE LABEL **Kingbright** Kingbright 30K / 55# Box 60K / 56# BOX Kingbright P/NO: KP-1608XXX Q C QTY: 2,000 pcs Q.C. XX XX XXXX S/N: XXXX CODE: XXX RoHS Compliant

Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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